



## ASSIGNMENT

WHEREAS I, Daniel F. Douriet of Fort Collins in the County of Larimer and the State of Colorado; have invented certain new and useful improvements in:

### **A LOW COST, WIDEBAND RF PORT STRUCTURE FOR MICROWAVE CIRCUIT PACKAGES USING COPLANAR WAVEGUIDE AND BGA I/O FORMAT**

for which I have filed application for Letters Patent of the United States on May 26, 1998;

AND WHEREAS, CIRCUIT COMPONENTS INCORPORATED, a corporation organized and existing under the laws of the State of Arizona, having a place of business at 2400 South Roosevelt Street, Tempe, Arizona 85282, is desirous of acquiring an interest, in the United States and all foreign countries, in and to the said invention and the Letters Patent to be obtained therefore;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for and in consideration of one (\$1.00) dollar to me in hand paid, and other good and valuable considerations, the receipt of all of which is hereby acknowledged, I, the said Daniel F. Douriet; have sold, assigned and transferred, and by these presents do sell, assign and transfer unto said CIRCUIT COMPONENTS INCORPORATED, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application which I have executed on the date set forth hereunder; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuation-in-part, divisions and reissues thereof, to the said CIRCUIT COMPONENTS INCORPORATED, as assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the CIRCUIT COMPONENTS INCORPORATED, its successors and assigns; and I do hereby agree that the said CIRCUIT COMPONENTS INCORPORATED, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said CIRCUIT COMPONENTS INCORPORATED, its successors or assigns, and that I will, at the cost and expense of the said CIRCUIT COMPONENTS INCORPORATED fully assist and cooperate

in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like

so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 7-7-98

Daniel F. Douriet L.S.  
Daniel F. Douriet